

Features

- Offset Voltage: 100 μ V (max)
- Low Noise: 13nV/ $\sqrt{\text{Hz}}$ (f= 1kHz)
- Supply Current: 190 μ A/ch
- Low THD+N: 0.0005%
- Supply Range: 2.2V to 5.5V
- Low Input Bias Current: 0.3pA Typical
- Slew Rate: 0.9 V/ μ s
- EMIRR IN+: 85 dB(under 2.4GHz)
- Gain-bandwidth Product: 1.6MHz
- Rail-to-Rail I/O
- High Output Current: 70mA (1.0V Drop)
- -40°C to 125°C Operation Range

Applications

- Photodiode detection
- High Impedance Sensor Amplifier
- Microvolt Accuracy Threshold Detection
- Instrumentation Amplifiers
- Communications
- Security
- Battery Powered Applications

Description

The TP2331/TP2332/TP2334 are single/dual/quad, low offset, low noise operational amplifiers with low power consumption and rail-to-rail input/output swing.

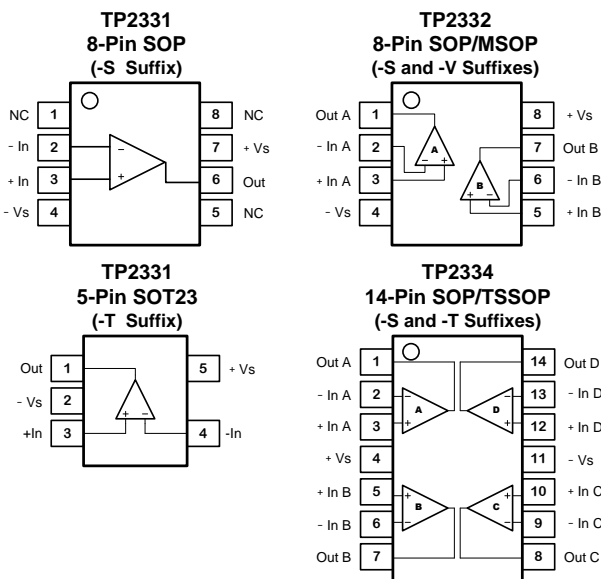
Input offset voltage is trimmed to less than 100 μ V and the CMOS inputs draw less than 0.3pA of bias current. The low offset drift, excellent CMRR, and high voltage gain make it a good choice for precision signal conditioning.

Each amplifier draws only 190 μ A current on a 3V supply. The micro power, rail-to-rail operation of the TP233x series is well suited for portable instruments and single supply applications.

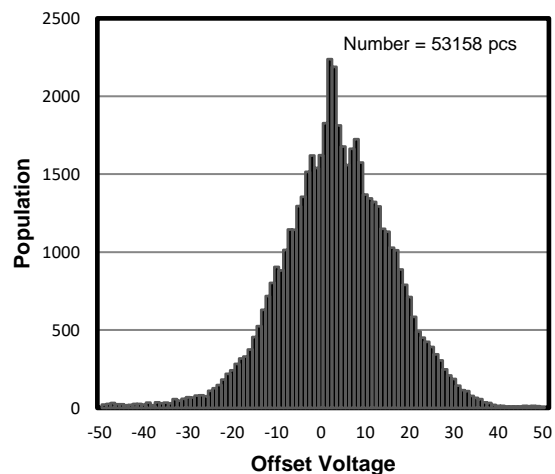
The TP2331 is single channel version available in 8-pin SOP and 5-pin SOT23 packages. The TP2332 is dual channel version available in 8-pin SOP and MSOP packages. The TP2334 is quad channel version available in 14-pin SOP and TSSOP packages.

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Pin Configuration (Top View)



Offset Voltage Production Distribution



Order Information

TP2331 / TP2332 / TP2334

1.6MHz Bandwidth, Low Noise Precision Op-amps

Model Name	Order Number	Package	Transport Media, Quantity	Marking Information
TP2331	TP2331-TR	5-Pin SOT23	Tape and Reel, 3,000	331
TP2332	TP2332-SR	8-Pin SOP	Tape and Reel, 4,000	TP2332
	TP2332-VR	8-Pin MSOP	Tape and Reel, 3,000	TP2332
TP2334	TP2334-SR ^{Note 1}	14-Pin SOP	Tape and Reel, 2,500	TP2334
	TP2334-TR ^{Note 1}	14-Pin TSSOP	Tape and Reel, 3,000	TP2334

Note 1: Future product, contact 3PEAK factory for more information and sample.

Absolute Maximum Ratings ^{Note 1}

Supply Voltage: $V^+ - V^-$ ^{Note 2} 7.0V
 Input Voltage $V^- - 0.3$ to $V^+ + 0.3$
 Input Current: +IN, -IN ^{Note 3} ± 20 mA
 Output Current: OUT ± 160 mA
 Output Short-Circuit Duration ^{Note 4} Indefinite

Current at Supply Pins ± 60 mA
 Operating Temperature Range -40°C to 125°C
 Maximum Junction Temperature 150°C
 Storage Temperature Range -65°C to 150°C
 Lead Temperature (Soldering, 10 sec) 260°C

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The op amp supplies must be established simultaneously, with, or before, the application of any input signals.

Note 3: The inputs are protected by ESD protection diodes to each power supply. If the input extends more than 500mV beyond the power supply, the input current should be limited to less than 10mA.

Note 4: A heat sink may be required to keep the junction temperature below the absolute maximum. This depends on the power supply voltage and how many amplifiers are shorted. Thermal resistance varies with the amount of PC board metal connected to the package. The specified values are for short traces connected to the leads.

ESD, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Minimum Level	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001	4	kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002	1	kV

Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
5-Pin SOT23	250	81	$^\circ\text{C/W}$
8-Pin SOP	158	43	$^\circ\text{C/W}$
8-Pin MSOP	210	45	$^\circ\text{C/W}$
14-Pin SOP	120	36	$^\circ\text{C/W}$
14-Pin TSSOP	180	35	$^\circ\text{C/W}$

1.6MHz Bandwidth, Low Noise Precision Op-amps

Electrical Characteristics

The specifications are at $T_A = 27^\circ\text{C}$. $V_S = +2.7\text{ V to }+5.5\text{ V}$, or $\pm 1.35\text{ V to } \pm 2.75\text{ V}$, $R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$. Unless otherwise noted.

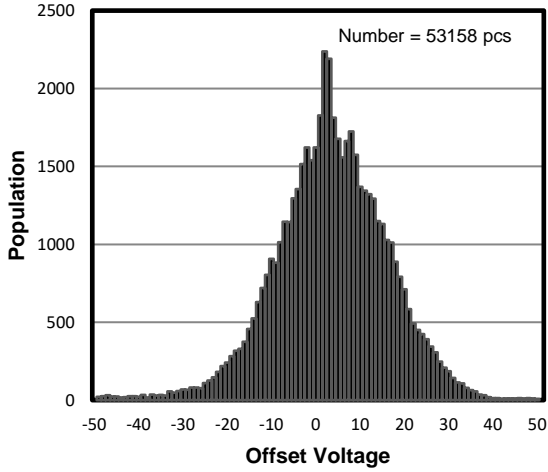
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{OS}	Input Offset Voltage	$V_{CM} = V_{DD}/2$, $V_{DD} = 5\text{V}$	-100	± 2	+100	μV
$V_{OS\ TC}$	Input Offset Voltage Drift	$-40^\circ\text{C to } 125^\circ\text{C}$		1		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current	$T_A = 27^\circ\text{C}$		0.3		pA
		$T_A = 85^\circ\text{C}$		150		pA
		$T_A = 125^\circ\text{C}$		300		pA
I_{OS}	Input Offset Current			0.001		pA
V_n	Input Voltage Noise	$f = 0.1\text{Hz to } 10\text{Hz}$		4.1		μV_{PP}
e_n	Input Voltage Noise Density	$f = 1\text{kHz}$		13		$\text{nV}/\sqrt{\text{Hz}}$
i_n	Input Current Noise	$f = 1\text{kHz}$		2		$\text{fA}/\sqrt{\text{Hz}}$
C_{IN}	Input Capacitance	Differential		7.76		pF
		Common Mode		6.87		
CMRR	Common Mode Rejection Ratio	$V_{CM} = 2\text{V to } 3\text{V}$	85	110		dB
V_{CM}	Common-mode Input Voltage Range		$V^- - 0.1$		$V^+ + 0.1$	V
PSRR	Power Supply Rejection Ratio	$V_{CM} = 2.5\text{V}$, $V_S = 4.8\text{V to } 5\text{V}$	75	100		dB
A_{VOL}	Open-Loop Large Signal Gain	$R_{LOAD} = 2\text{ k}\Omega$	100	130		dB
V_{OL} , V_{OH}	Output Swing from Supply Rail	$R_{LOAD} = 2\text{ k}\Omega$		15	45	mV
R_{OUT}	Closed-Loop Output Impedance	$G = 1$, $f = 1\text{kHz}$, $I_{OUT} = 0$		0.002		Ω
R_O	Open-Loop Output Impedance	$f = 1\text{kHz}$, $I_{OUT} = 0$		125		Ω
I_{SC}	Output Short-Circuit Current	Sink or source current	95	130		mA
V_{DD}	Supply Voltage		2.2		5.5	V
I_Q	Quiescent Current per Amplifier			190	280	μA
PM	Phase Margin	$R_{LOAD} = 1\text{ k}\Omega$, $C_{LOAD} = 60\text{ pF}$		80		$^\circ$
GM	Gain Margin	$R_{LOAD} = 1\text{ k}\Omega$, $C_{LOAD} = 60\text{ pF}$		15		dB
GBWP	Gain-Bandwidth Product	$f = 1\text{kHz}$		1.6		MHz
SR	Slew Rate	$A_V = 1$, $V_{OUT} = 1.5\text{V to } 3.5\text{V}$, $C_{LOAD} = 60\text{ pF}$, $R_{LOAD} = 1\text{ k}\Omega$	0.36	0.84		$\text{V}/\mu\text{s}$
FPBW	Full Power Bandwidth ^{Note 1}			58.6		kHz
t_s	Settling Time, 0.1% Settling Time, 0.01%	$A_V = -1$, 1V Step		4.4		μs
				4.4		
THD+N	Total Harmonic Distortion and Noise	$f = 1\text{kHz}$, $A_V = 1$, $R_L = 2\text{ k}\Omega$, $V_{OUT} = 1\text{V}_{p-p}$		0.0003		$\%$
X_{talk}	Channel Separation	$f = 1\text{kHz}$, $R_L = 2\text{ k}\Omega$		110		dB

Note 1: Full power bandwidth is calculated from the slew rate $FPBW = SR/\pi \cdot V_{P-P}$

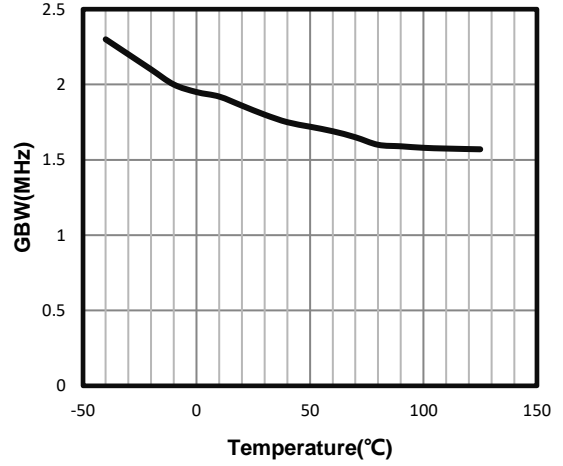
1.6MHz Bandwidth, Low Noise Precision Op-amps
Typical Performance Characteristics

$V_S = \pm 2.75V$, $V_{CM} = 0V$, $R_L = \text{Open}$, unless otherwise specified.

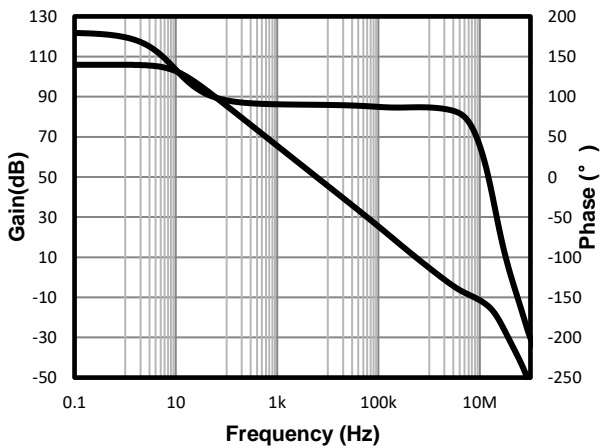
Offset Voltage Production Distribution



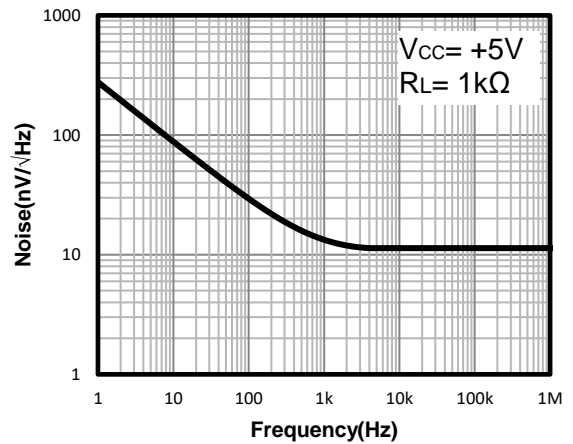
Unity Gain Bandwidth vs. Temperature



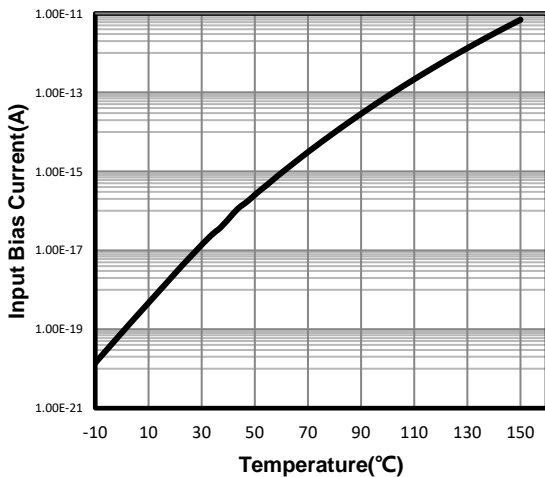
Open-Loop Gain and Phase



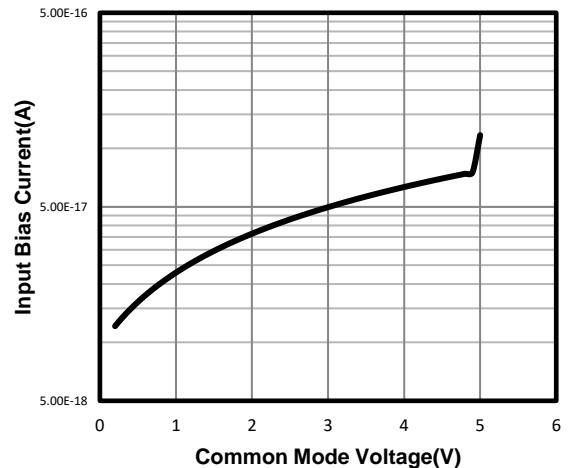
Input Voltage Noise Spectral Density



Input Bias Current vs. Temperature



Input Bias Current vs. Input Common Mode Voltage

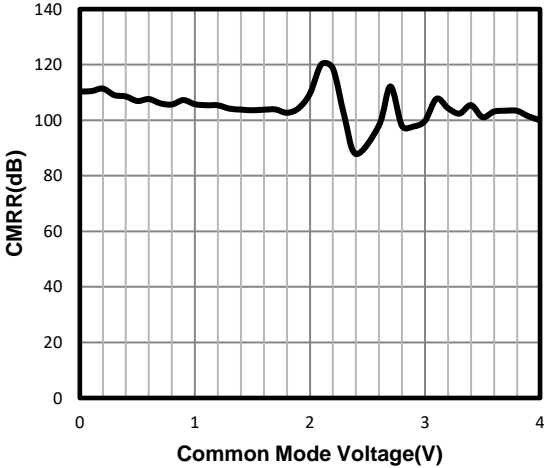


1.6MHz Bandwidth, Low Noise Precision Op-amps

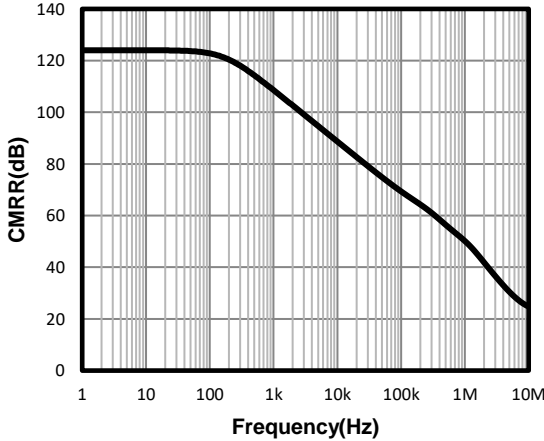
Typical Performance Characteristics

$V_S = \pm 2.75V$, $V_{CM} = 0V$, $R_L = \text{Open}$, unless otherwise specified. (Continued)

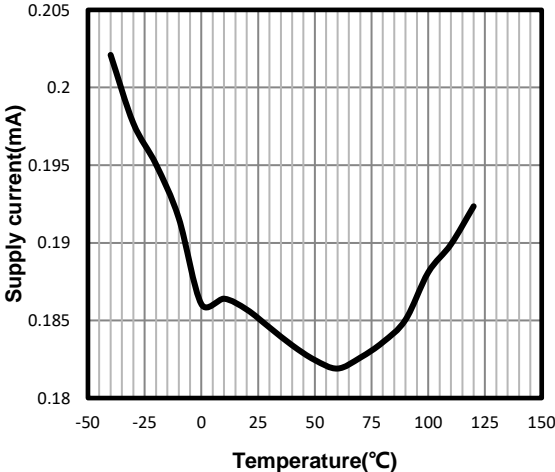
Common Mode Rejection Ratio



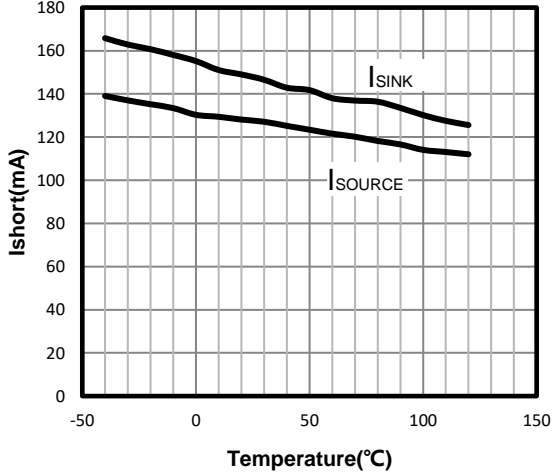
CMRR vs. Frequency



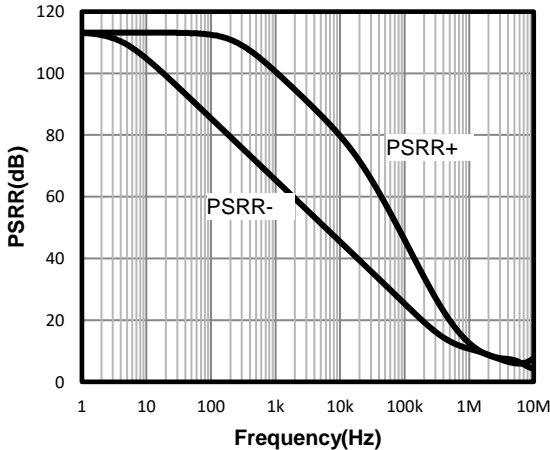
Quiescent Current vs. Temperature



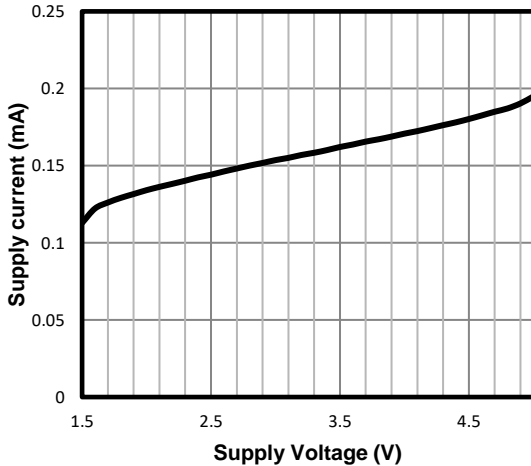
Short Circuit Current vs. Temperature



Power-Supply Rejection Ratio



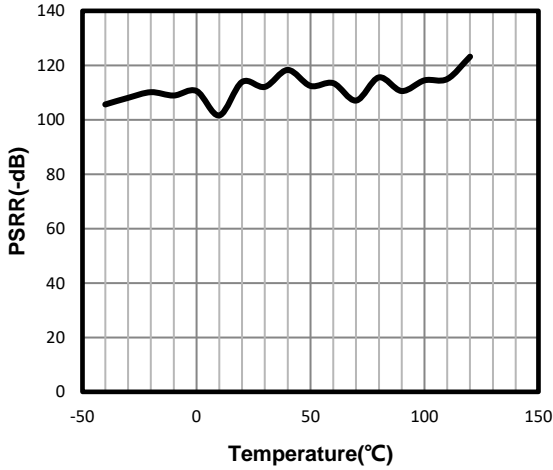
Quiescent Current vs. Supply Voltage



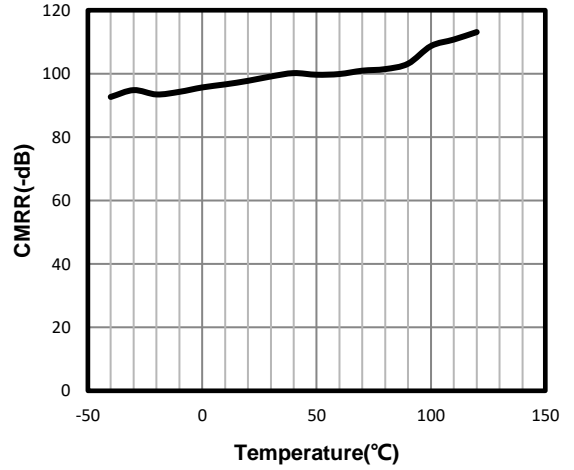
1.6MHz Bandwidth, Low Noise Precision Op-amps
Typical Performance Characteristics

$V_S = \pm 2.75V$, $V_{CM} = 0V$, $R_L = \text{Open}$, unless otherwise specified. (Continued)

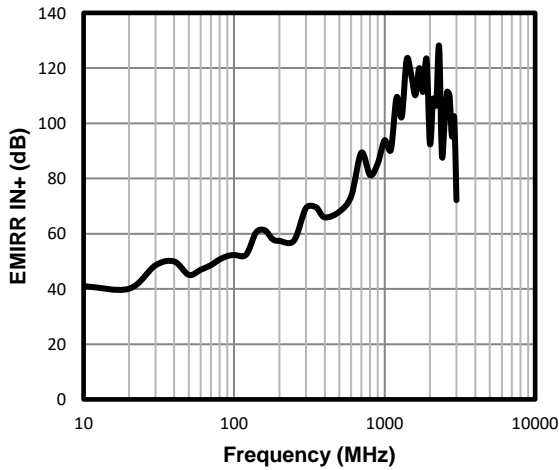
Power-Supply Rejection Ratio vs. Temperature



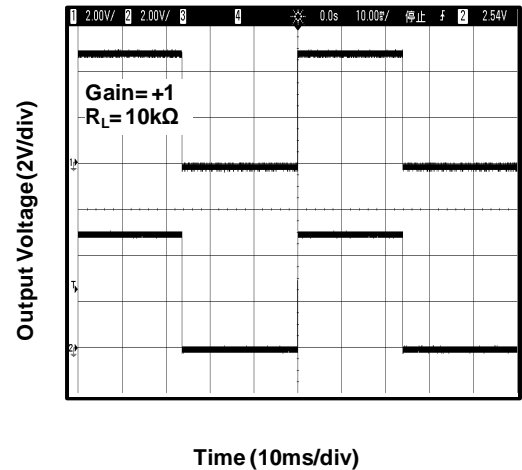
CMRR vs. Temperature



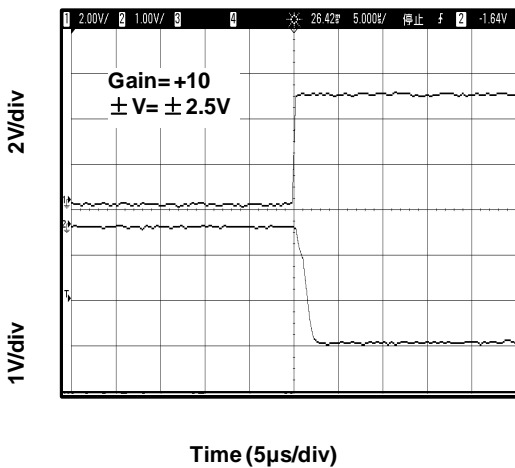
EMIRR IN+ vs. Frequency



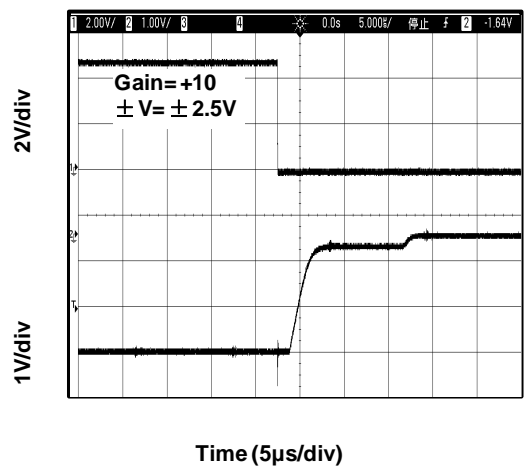
Large-Scale Step Response



Negative Over-Voltage Recovery



Positive Over-Voltage Recovery

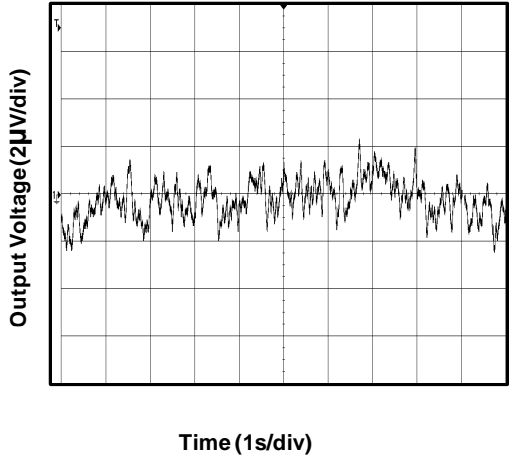


1.6MHz Bandwidth, Low Noise Precision Op-amps

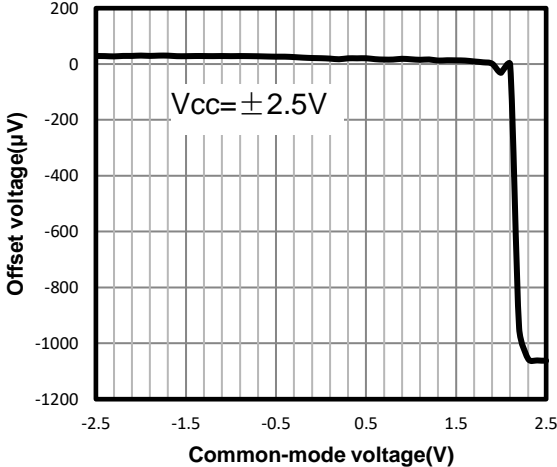
Typical Performance Characteristics

$V_s = \pm 2.75V$, $V_{CM} = 0V$, $R_L = \text{Open}$, unless otherwise specified. (Continued)

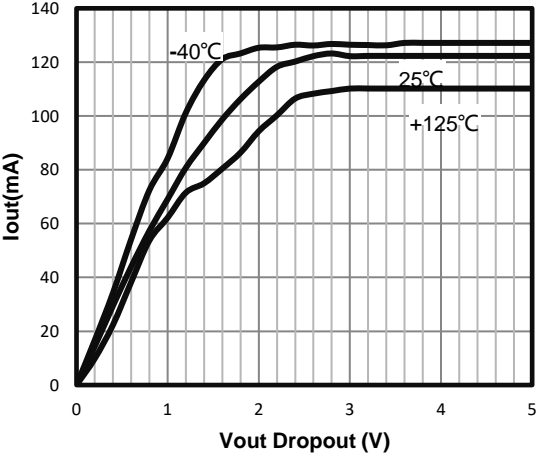
0.1 Hz TO 10 Hz Input Voltage Noise



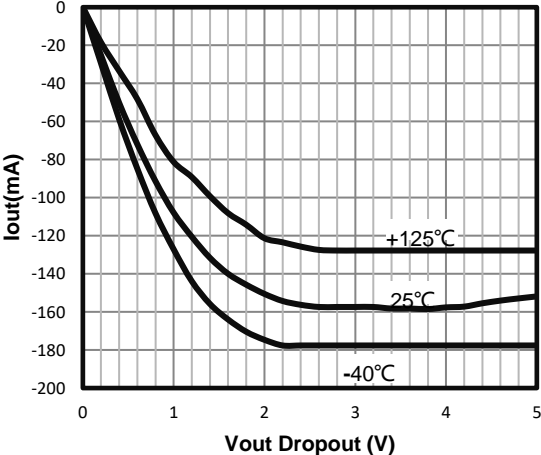
Offset Voltage vs Common-Mode Voltage



Positive Output Swing vs. Load Current



Negative Output Swing vs. Load Current



TP2331 / TP2332 / TP2334

1.6MHz Bandwidth, Low Noise Precision Op-amps

Pin Functions

-IN: Inverting Input of the Amplifier.

+IN: Non-Inverting Input of Amplifier.

OUT: Amplifier Output. The voltage range extends to within mV of each supply rail.

V+ or +Vs: Positive Power Supply. Typically the voltage is from 2.2V to 5.5V. Split supplies are possible as long as the voltage between V+ and V- is between 2.2V and 5.5V. A bypass capacitor of 0.1 μ F as close to the part as

possible should be used between power supply pins or between supply pins and ground.

V- or -Vs: Negative Power Supply. It is normally tied to ground. It can also be tied to a voltage other than ground as long as the voltage between V+ and V- is from 2.2V to 5.5V. If it is not connected to ground, bypass it with a capacitor of 0.1 μ F as close to the part as possible.

Operation

The TP2331/TP2332/TP2334 can operate from a single +2.2V to +5.5V power supply, or from ± 1.1 V to ± 2.75 V power supplies. The power supply pin(s) must be bypassed to ground with a 0.1 μ F capacitor as close to the pin as possible.

This series are high-precision op amps with a CMOS input stage and an excellent set of DC and AC features. The combination of tight maximum voltage offset, low offset tempco and very low input current make them ideal for use in high-precision DC circuits. They feature low-voltage operation, low-power consumption, high-current drive with rail-to-rail output swing and high-gain bandwidth product.

Applications Information

High Accuracy

The TP2331/TP2332/TP2334 maximum input offset voltage is 50 μ V (2 μ V, typ) at +25°C. The maximum temperature coefficient of the offset voltage are guaranteed to be 2 μ V/°C. The parts have an input bias current of 0.3pA. Noise characteristics are 13nV/ $\sqrt{\text{Hz}}$, and a low frequency noise (0.1Hz to 10Hz) of 4.1 μ Vp-p. The CMRR is 140dB, and the PSRR is 120dB. The combination is what is necessary for the design of circuits to process signals while keeping high signal-to-noise ratios, as in stages preceding high-resolution converters, or when they are produced by sensors or transducers generating very small outputs.

Rail-to-Rail Inputs and Outputs

The TP233x op amps are designed to be immune to phase reversal when the input pins exceed the supply voltages, therefore providing further in-system stability and predictability. Figure 1 shows the input voltage exceeding the supply voltage without any phase reversal.

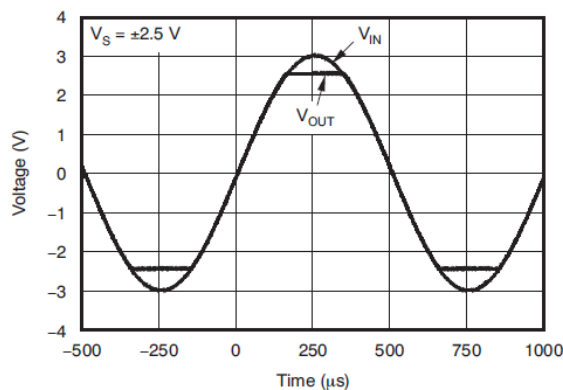


Figure 1. No Phase Reversal

1.6MHz Bandwidth, Low Noise Precision Op-amps

Input ESD Diode Protection

The TP2331 incorporates internal electrostatic discharge (ESD) protection circuits on all pins. In the case of input and output pins, this protection primarily consists of current-steering diodes connected between the input and power-supply pins. These ESD protection diodes also provide in-circuit input overdrive protection, as long as the current is limited to 10 mA as stated in the Absolute Maximum Ratings table. Many input signals are inherently current-limited to less than 10 mA; therefore, a limiting resistor is not required. Figure 2 shows how a series input resistor (RS) may be added to the driven input to limit the input current. The added resistor contributes thermal noise at the amplifier input and the value should be kept to the minimum in noise-sensitive applications.

Current-limiting resistor required if input voltage exceeds supply rails by >0.5V.

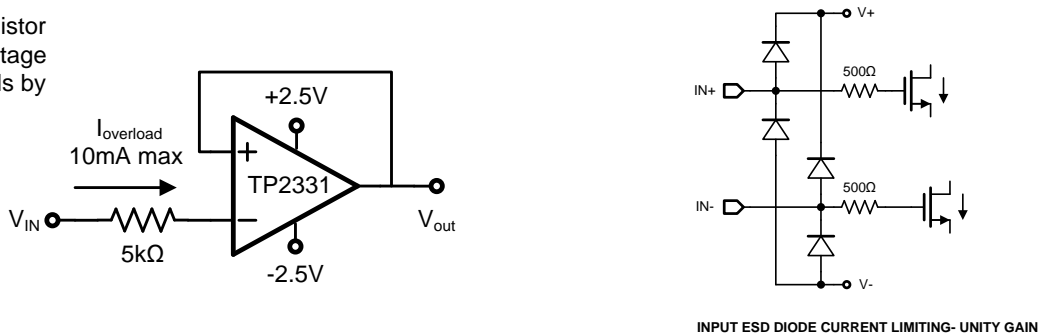


Figure2. Input ESD Diode

EMI Susceptibility and Input Filtering

Operational amplifiers vary in susceptibility to electromagnetic interference (EMI). If conducted EMI enters the device, the dc offset observed at the amplifier output may shift from the nominal value while EMI is present. This shift is a result of signal rectification associated with the internal semiconductor junctions. While all operational amplifier pin functions can be affected by EMI, the input pins are likely to be the most susceptible. The TP2331 operational amplifier family incorporates an internal input low-pass filter that reduces the amplifier response to EMI. Both common-mode and differential mode filtering are provided by the input filter. The filter is designed for a cutoff frequency of approximately 400 MHz (–3 dB), with a roll-off of 20 dB per decade.

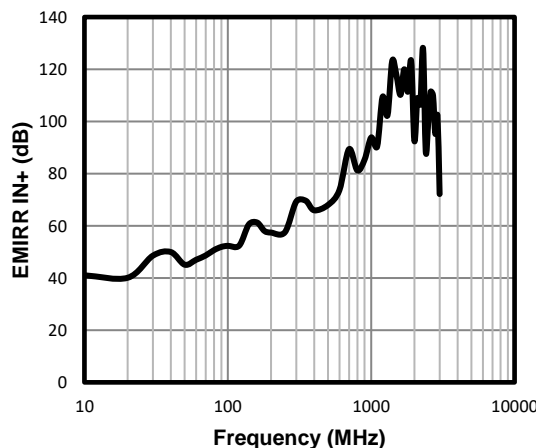


Figure 3. TP2331 EMIRR IN+ vs Frequency

Typical Application

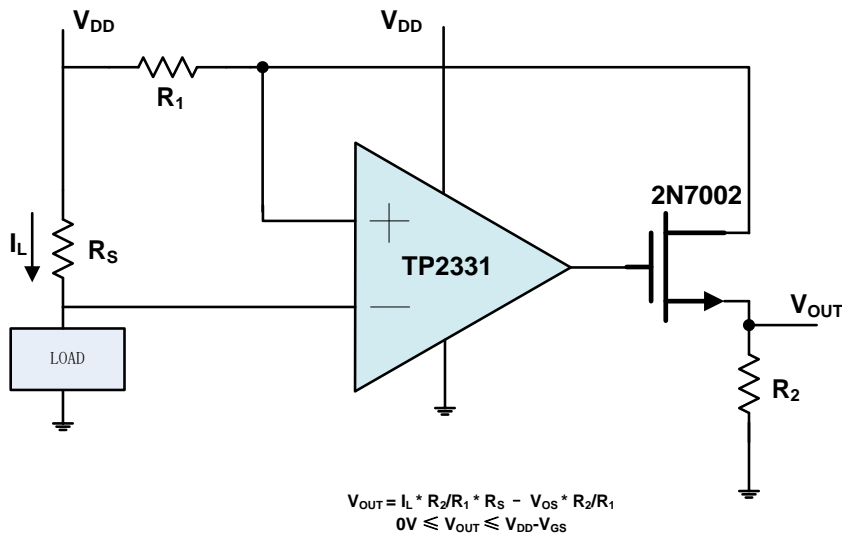


Figure 4. 2.7V High Side Current Sense

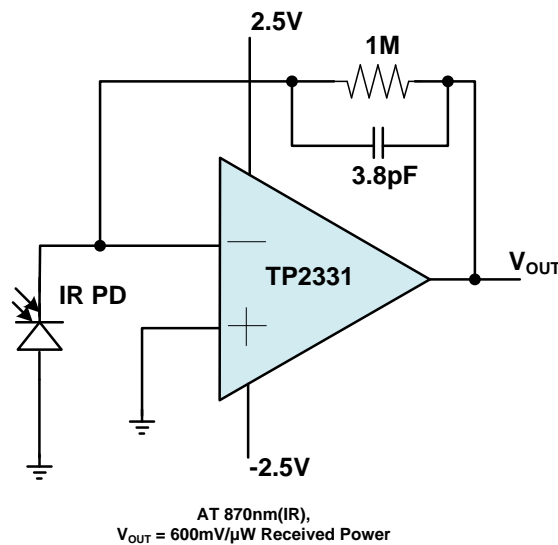


Figure 5. Photodiode Amplifier

PCB Surface Leakage

In applications where low input bias current is critical, Printed Circuit Board (PCB) surface leakage effects need to be considered. Surface leakage is caused by humidity, dust or other contamination on the board. Under low humidity conditions, a typical resistance between nearby traces is $10^{12}\Omega$. A 5V difference would cause 5pA of current to flow, which is greater than the TP2331/2332/2334 OPA's input bias current at +27°C ($\pm 0.3pA$, typical). It is recommended to use multi-layer PCB layout and route the OPA's -IN and +IN signal under the PCB surface.

The effective way to reduce surface leakage is to use a guard ring around sensitive pins (or traces). The guard ring is biased at the same voltage as the sensitive pin. An example of this type of layout is shown in Figure 6 for Inverting Gain application.

1.6MHz Bandwidth, Low Noise Precision Op-amps

1. For Non-Inverting Gain and Unity-Gain Buffer:

- Connect the non-inverting pin (V_{IN+}) to the input with a wire that does not touch the PCB surface.
- Connect the guard ring to the inverting input pin (V_{IN-}). This biases the guard ring to the Common Mode input voltage.

2. For Inverting Gain and Trans-impedance Gain Amplifiers (convert current to voltage, such as photo detectors):

- Connect the guard ring to the non-inverting input pin (V_{IN+}). This biases the guard ring to the same reference voltage as the op-amp (e.g., $V_{DD}/2$ or ground).
- Connect the inverting pin (V_{IN-}) to the input with a wire that does not touch the PCB surface.

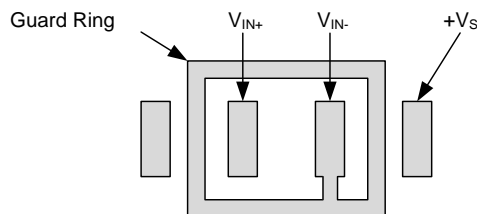


Figure 6 The Layout of Guard Ring

Power Supply Layout and Bypass

The TP2331/2332/2332 OPA's power supply pin (V_{DD} for single-supply) should have a local bypass capacitor (i.e., $0.01\mu\text{F}$ to $0.1\mu\text{F}$) within 2mm for good high frequency performance. It can also use a bulk capacitor (i.e., $1\mu\text{F}$ or larger) within 100mm to provide large, slow currents. This bulk capacitor can be shared with other analog parts.

Ground layout improves performance by decreasing the amount of stray capacitance and noise at the OPA's inputs and outputs. To decrease stray capacitance, minimize PCB lengths and resistor leads, and place external components as close to the op amps' pins as possible.

Proper Board Layout

To ensure optimum performance at the PCB level, care must be taken in the design of the board layout. To avoid leakage currents, the surface of the board should be kept clean and free of moisture. Coating the surface creates a barrier to moisture accumulation and helps reduce parasitic resistance on the board.

Keeping supply traces short and properly bypassing the power supplies minimizes power supply disturbances due to output current variation, such as when driving an ac signal into a heavy load. Bypass capacitors should be connected as closely as possible to the device supply pins. Stray capacitances are a concern at the outputs and the inputs of the amplifier. It is recommended that signal traces be kept at least 5mm from supply lines to minimize coupling.

A variation in temperature across the PCB can cause a mismatch in the Seebeck voltages at solder joints and other points where dissimilar metals are in contact, resulting in thermal voltage errors. To minimize these thermocouple effects, orient resistors so heat sources warm both ends equally. Input signal paths should contain matching numbers and types of components, where possible to match the number and type of thermocouple junctions. For example, dummy components such as zero value resistors can be used to match real resistors in the opposite input path. Matching components should be located in close proximity and should be oriented in the same manner. Ensure leads are of equal length so that thermal conduction is in equilibrium. Keep heat sources on the PCB as far away from amplifier input circuitry as is practical.

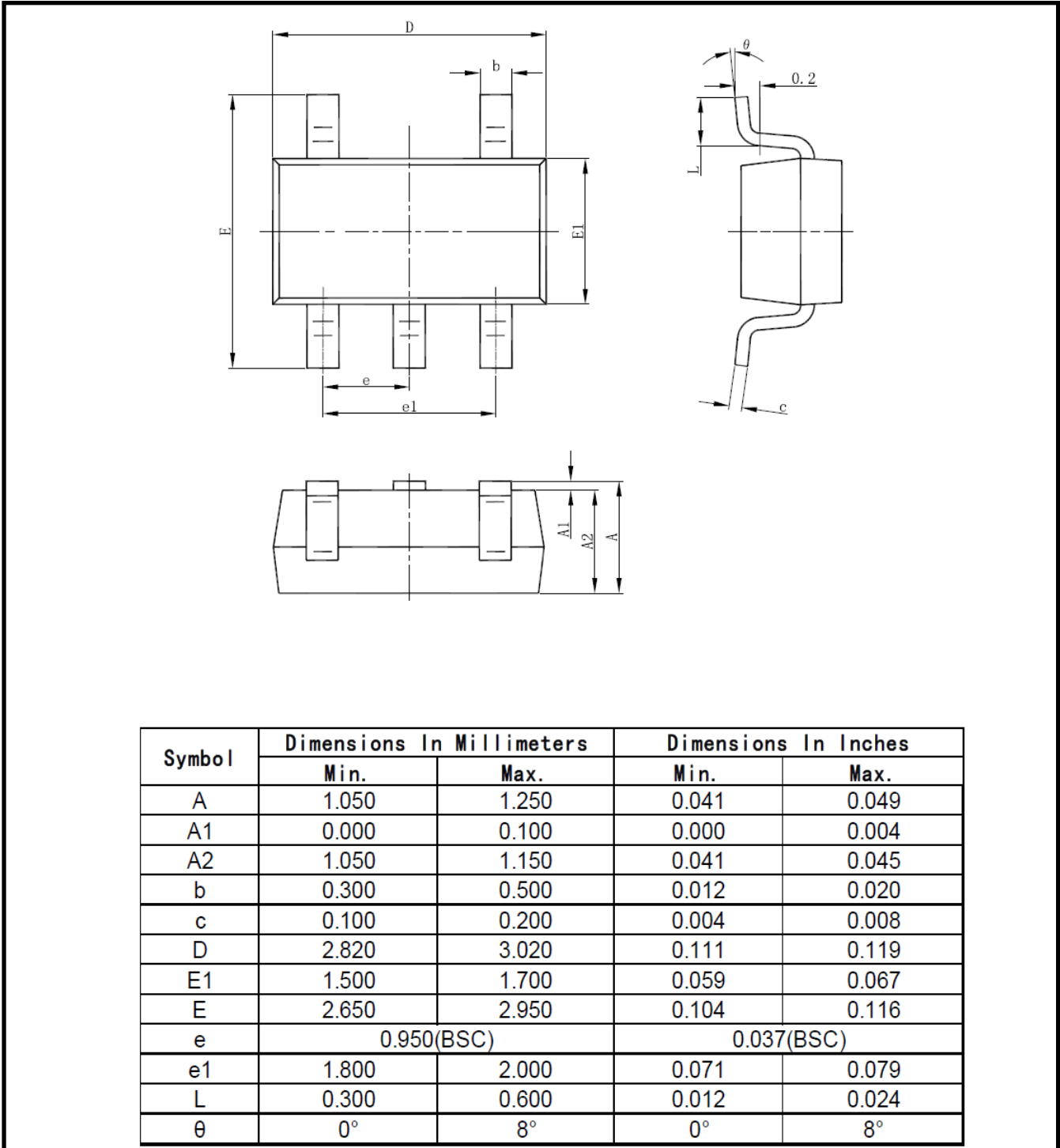
The use of a ground plane is highly recommended. A ground plane reduces EMI noise and also helps to maintain a constant temperature across the circuit board.

TP2331 / TP2332 / TP2334

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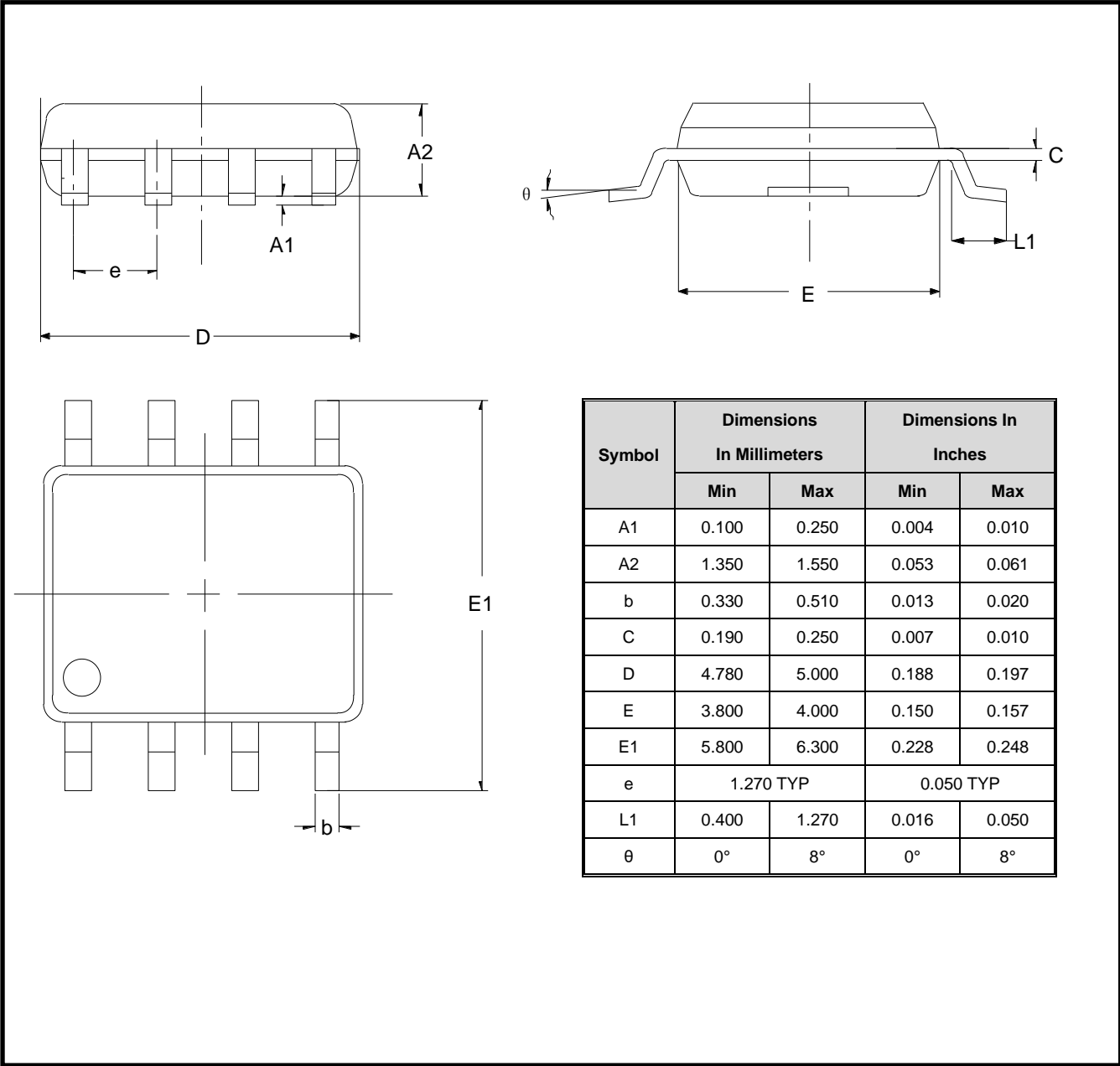
Package Outline Dimensions

SOT23-5



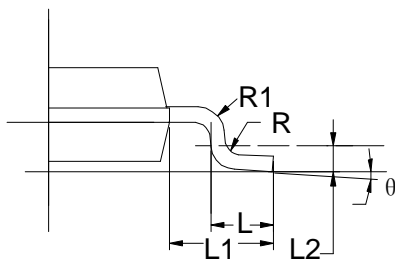
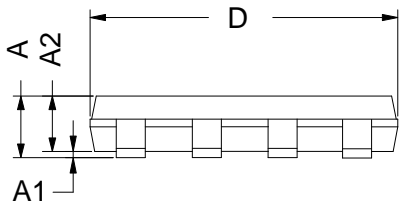
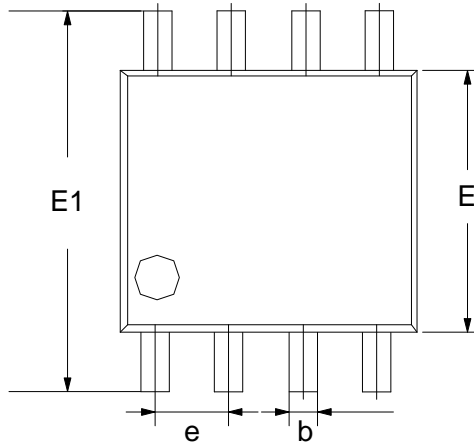
Package Outline Dimensions

SOP-8



Package Outline Dimensions

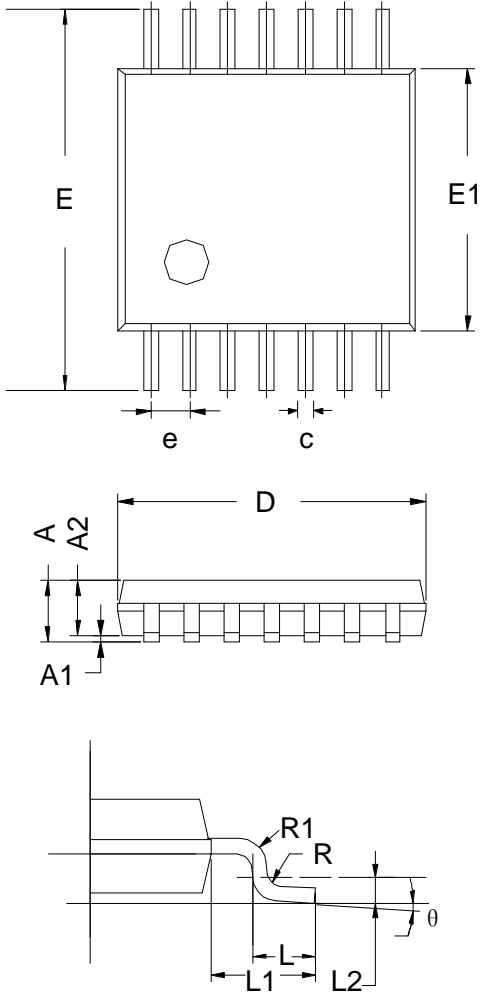
MSOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.200	0.031	0.047
A1	0.000	0.200	0.000	0.008
A2	0.760	0.970	0.030	0.038
b	0.30 TYP		0.012 TYP	
C	0.15 TYP		0.006 TYP	
D	2.900	3.100	0.114	0.122
e	0.65 TYP		0.026	
E	2.900	3.100	0.114	0.122
E1	4.700	5.100	0.185	0.201
L1	0.410	0.650	0.016	0.026
θ	0°	6°	0°	6°

Package Outline Dimensions

TSSOP-14



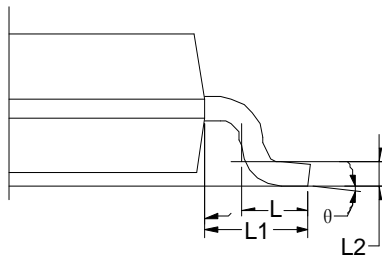
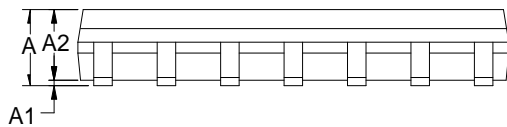
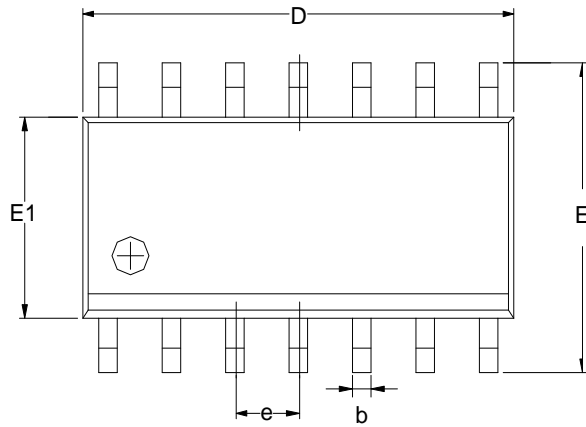
Symbol	Dimensions In Millimeters		
	MIN	TYP	MAX
A	-	-	1.20
A1	0.05	-	0.15
A2	0.90	1.00	1.05
b	0.20	-	0.28
c	0.10	-	0.19
D	4.86	4.96	5.06
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
e	0.65 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		
L2	0.25 BSC		
R	0.09	-	-
θ	0°	-	8°

TP2331 / TP2332 / TP2334

1.6MHz Bandwidth, Low Noise Precision Op-amps

Package Outline Dimensions

SOP-14



Symbol	Dimensions In Millimeters		
	MIN	TYP	MAX
A	1.35	1.60	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.65
b	0.36		0.49
D	8.53	8.63	8.73
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27 BSC		
L	0.45	0.60	0.80
L1	1.04 REF		
L2	0.25 BSC		
θ	0°		8°

Revision History

Date	Revision	Notes
2022/4/29	A.2	Update order information.

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